

## NCE N-Channel Super Trench Power MOSFET

### Description

The NCEP1520K uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

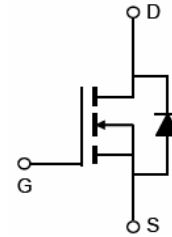
### General Features

- $V_{DS} = 150V, I_D = 20A$   
 $R_{DS(ON)} = 59m\Omega$  (typical) @  $V_{GS} = 10V$
- Excellent gate charge x  $R_{DS(on)}$  product(FOM)
- Very low on-resistance  $R_{DS(on)}$
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

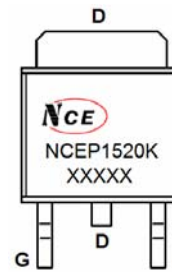
### Application

- LED backlighting
- Ideal for high-frequency switching and synchronous rectification

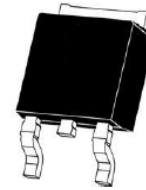
**100% UIS TESTED!**



Schematic diagram



Marking and pin assignment



TO-252 -2L top view

### Package Marking and Ordering Information

| Device Marking | Device    | Device Package | Reel Size | Tape width | Quantity   |
|----------------|-----------|----------------|-----------|------------|------------|
| NCEP1520K      | NCEP1520K | TO-252-2L      | Ø330mm    | 12mm       | 2500 units |

### Absolute Maximum Ratings ( $T_A = 25^\circ C$ unless otherwise noted)

| Parameter   | Symbol             | Limit      | Unit          |
|---|--------------------|------------|---------------|
| Drain-Source Voltage  | $V_{DS}$           | 150        | V             |
| Gate-Source Voltage   | $V_{GS}$           | $\pm 20$   | V             |
| Drain Current-Continuous                                      | $I_D$              | 20         | A             |
| Drain Current-Continuous( $T_C = 100^\circ C$ )               | $I_D(100^\circ C)$ | 14         | A             |
| Pulsed Drain Current  | $I_{DM}$           | 80         | A             |
| Maximum Power Dissipation                                     | $P_D$              | 68         | W             |
| Derating factor   |                    | 0.45       | W/ $^\circ C$ |
| Single pulse avalanche energy <sup>(Note 5)</sup>             | $E_{AS}$           | 65         | mJ            |
| Drain Source voltage slope, $V_{DS} \leq 120 V$ ,             | $dv/dt$            | 50         | V/ns          |
| Drain Source voltage slope, $V_{DS} \leq 120 V, I_{SD} < I_D$ | $dv/dt$            | 50         | V/ns          |
| Operating Junction and Storage Temperature Range              | $T_J, T_{STG}$     | -55 To 175 | $^\circ C$    |

## Thermal Characteristic

|  |                 |     |               |
|--|-----------------|-----|---------------|
| Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup> | $R_{\theta JC}$ | 2.2 | $^{\circ}C/W$ |
|--|-----------------|-----|---------------|

## Electrical Characteristics ( $T_A=25^{\circ}C$ unless otherwise noted)

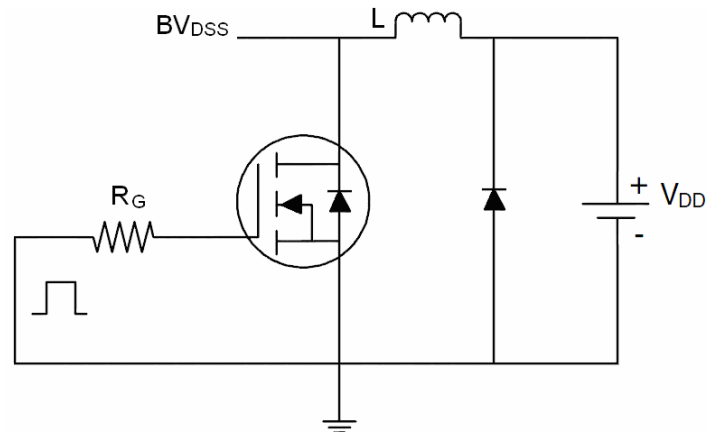
| Parameter  | Symbol       | Condition  | Min | Typ  | Max       | Unit       |
|--|--------------|--|-----|------|-----------|------------|
| <b>Off Characteristics</b>                           |              |  |     |      |           |            |
| Drain-Source Breakdown Voltage                       | $BV_{DSS}$   | $V_{GS}=0V, I_D=250\mu A$  | 150 | -    | -         | V          |
| Zero Gate Voltage Drain Current                      | $I_{DSS}$    | $V_{DS}=150V, V_{GS}=0V$   | -   | -    | 1         | $\mu A$    |
| Gate-Body Leakage Current                            | $I_{GSS}$    | $V_{GS}=\pm 20V, V_{DS}=0V$  | -   | -    | $\pm 100$ | nA         |
| <b>On Characteristics</b> <sup>(Note 3)</sup>        |              |  |     |      |           |            |
| Gate Threshold Voltage                               | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$  | 2.5 | 3.3  | 4.5       | V          |
| Drain-Source On-State Resistance                     | $R_{DS(ON)}$ | $V_{GS}=10V, I_D=10A$  | -   | 59   | 65        | m $\Omega$ |
| Gate resistance                                      | $R_G$        |  | -   | 4.5  | -         | $\Omega$   |
| Forward Transconductance                             | $g_{FS}$     | $V_{DS}=5V, I_D=10A$   | 15  | -    | -         | S          |
| <b>Dynamic Characteristics</b> <sup>(Note 4)</sup>   |              |  |     |      |           |            |
| Input Capacitance                                    | $C_{ISS}$    | $V_{DS}=75V, V_{GS}=0V,$<br>$F=1.0MHz$                                     | -   | 600  |           | PF         |
| Output Capacitance                                   | $C_{OSS}$    |  | -   | 74.7 |           | PF         |
| Reverse Transfer Capacitance                         | $C_{RSS}$    |  | -   | 10.8 |           | PF         |
| <b>Switching Characteristics</b> <sup>(Note 4)</sup> |              |  |     |      |           |            |
| Turn-on Delay Time                                   | $t_{d(on)}$  | $V_{DD}=75V, R_L=7.5\Omega$<br>$V_{GS}=10V, R_G=3\Omega$                   | -   | 9.5  | -         | nS         |
| Turn-on Rise Time                                    | $t_r$        |  | -   | 5.5  | -         | nS         |
| Turn-Off Delay Time                                  | $t_{d(off)}$ |  | -   | 12.5 | -         | nS         |
| Turn-Off Fall Time                                   | $t_f$        |  | -   | 3    | -         | nS         |
| Total Gate Charge                                    | $Q_g$        | $V_{DS}=75V, I_D=10A,$<br>$V_{GS}=10V$                                     | -   | 12   | -         | nC         |
| Gate-Source Charge                                   | $Q_{gs}$     |  | -   | 5.7  | -         | nC         |
| Gate-Drain Charge                                    | $Q_{gd}$     |  | -   | 2.7  | -         | nC         |
| <b>Drain-Source Diode Characteristics</b>            |              |  |     |      |           |            |
| Diode Forward Voltage <sup>(Note 3)</sup>            | $V_{SD}$     | $V_{GS}=0V, I_S=10A$   | -   | -    | 1.2       | V          |
| Diode Forward Current <sup>(Note 2)</sup>            | $I_S$        |  | -   | -    | 20        | A          |
| Reverse Recovery Time                                | $t_{rr}$     | $T_J = 25^{\circ}C, I_F = I_S$<br>$di/dt = 100A/\mu s$ <sup>(Note 3)</sup> | -   | 29   | -         | nS         |
| Reverse Recovery Charge                              | $Q_{rr}$     |  | -   | 130  | -         | nC         |

### Notes:

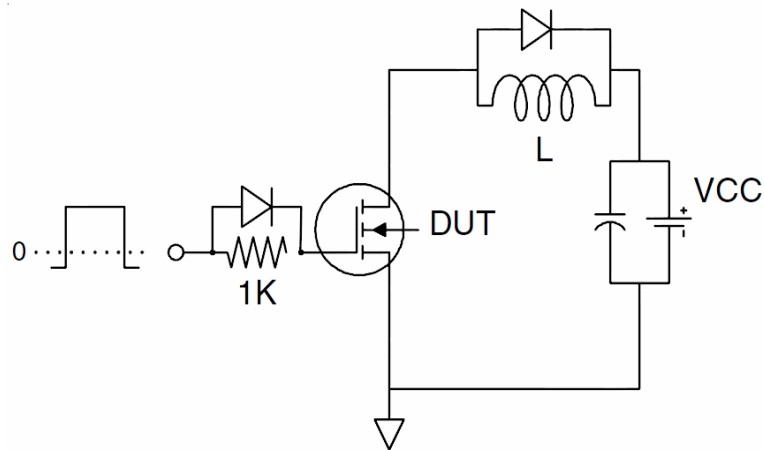
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production
5. EAS condition :  $T_J=25^{\circ}C, V_{DD}=50V, V_G=10V, L=0.5mH, R_G=25\Omega$

## Test Circuit

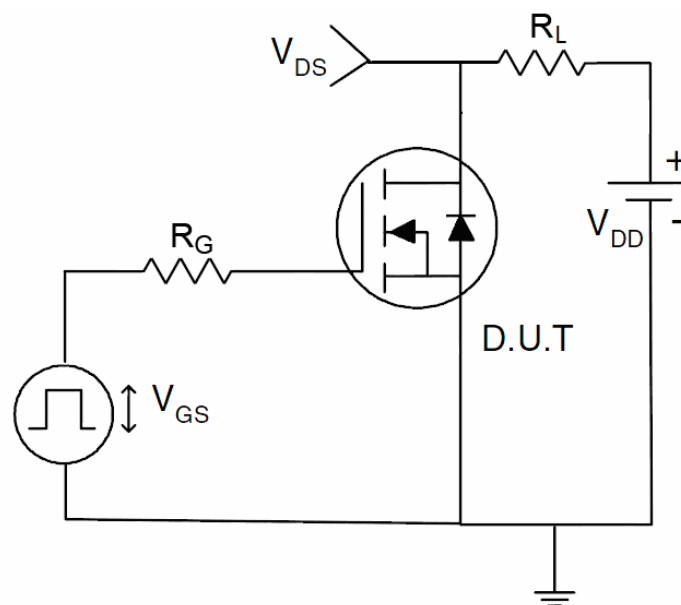
### 1) $E_{AS}$ test Circuit



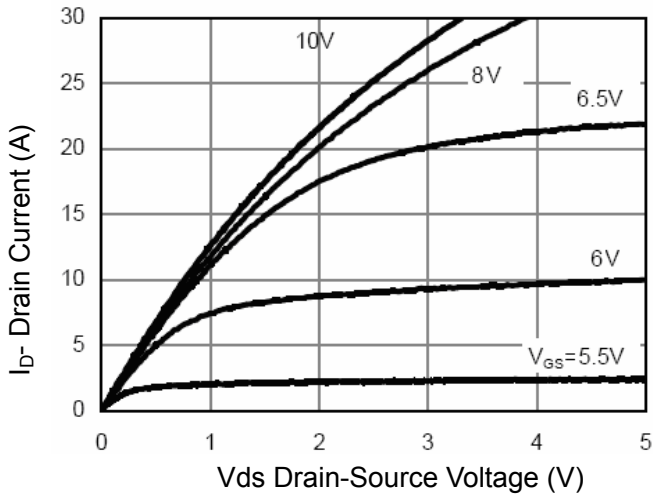
### 2) Gate charge test Circuit



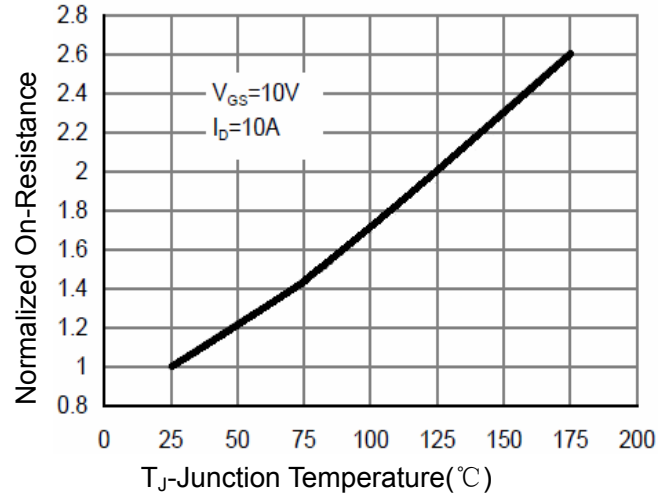
### 3) Switch Time Test Circuit



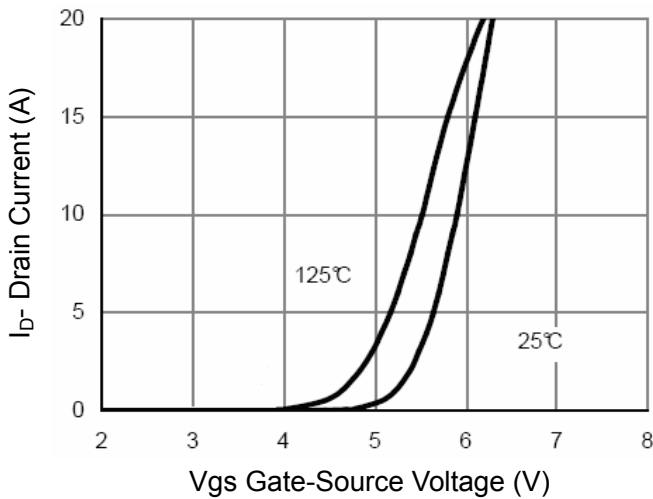
**Typical Electrical and Thermal Characteristics**



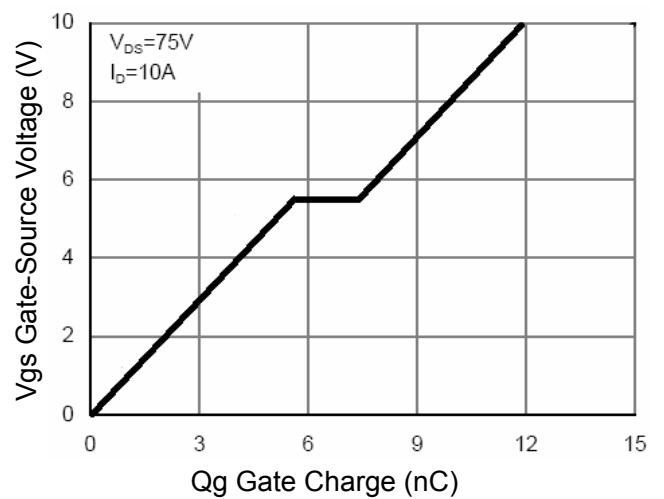
**Figure 1 Output Characteristics**



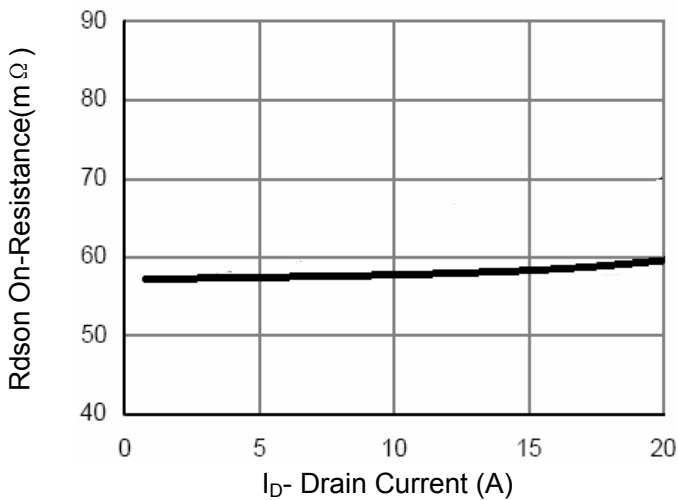
**Figure 4  $R_{dson}$ -Junction Temperature**



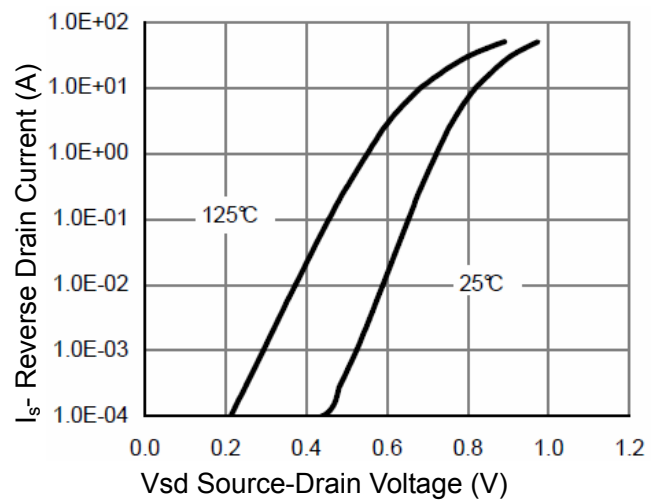
**Figure 2 Transfer Characteristics**



**Figure 5 Gate Charge**



**Figure 3  $R_{dson}$ - Drain Current**



**Figure 6 Source- Drain Diode Forward**

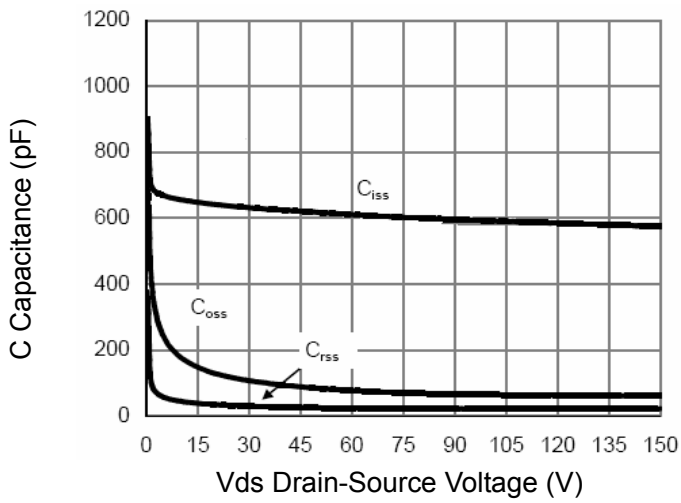


Figure 7 Capacitance vs Vds

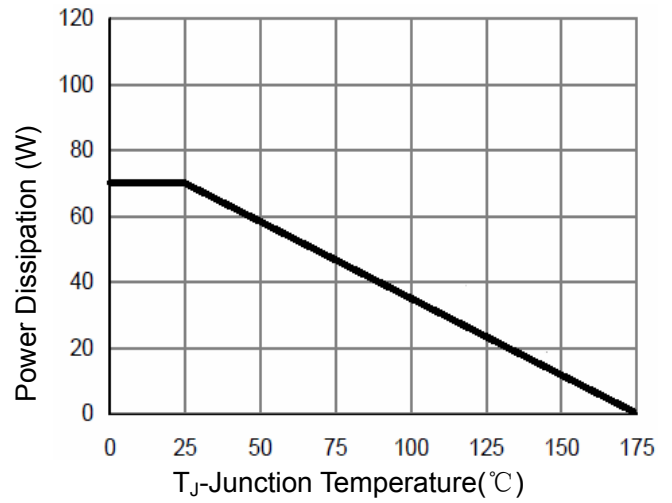


Figure 9 Power De-rating

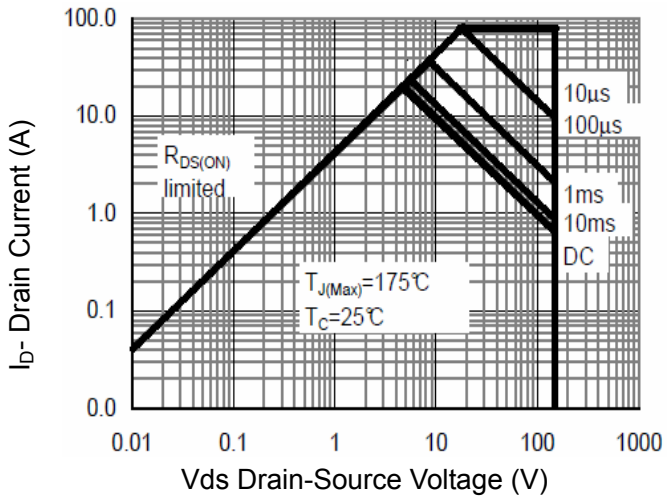


Figure 8 Safe Operation Area

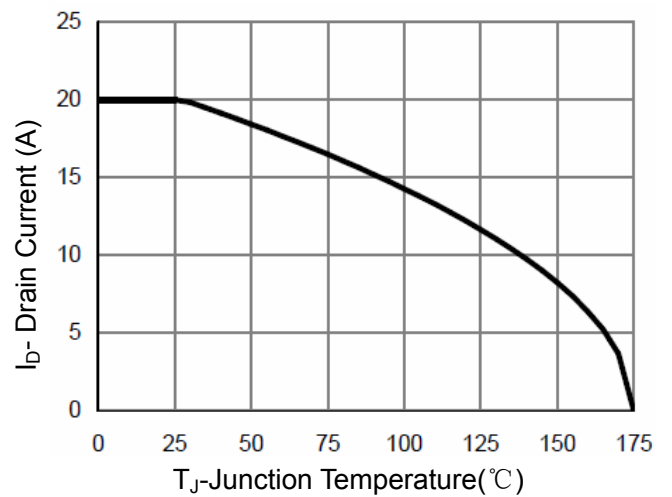


Figure 10 Current De-rating

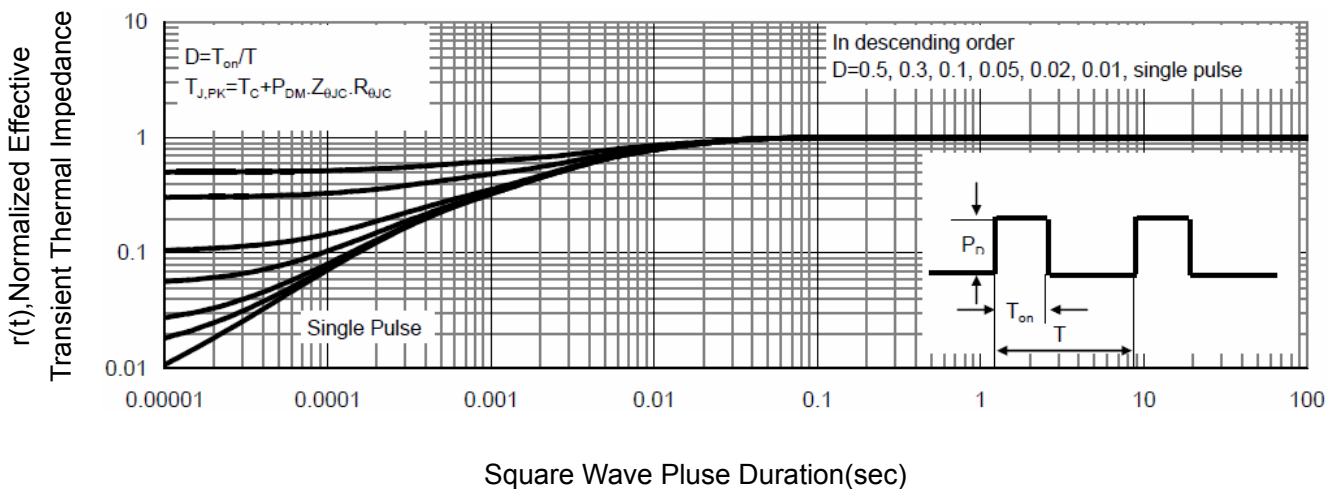
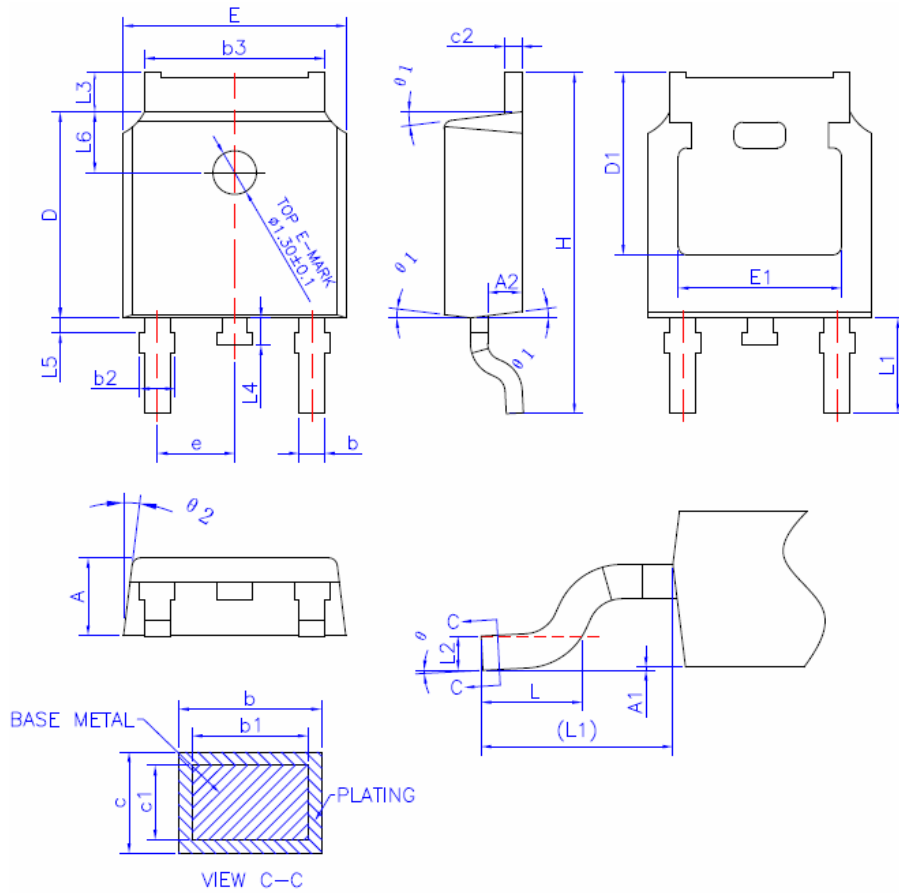


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-252-2L Package Information



COMMON DIMENSIONS  
(UNITS OF MEASURE =MILLIMETER)

| SYMBOL  | MIN       | NOM   | MAX   |
|---------|-----------|-------|-------|
| A       | 2.20      | 2.30  | 2.38  |
| A1      | 0         | —     | 0.10  |
| A2      | 0.90      | 1.01  | 1.10  |
| b       | 0.72      | —     | 0.85  |
| b1      | 0.71      | 0.76  | 0.81  |
| b2      | 0.72      | —     | 0.90  |
| b3      | 5.13      | 5.33  | 5.46  |
| c       | 0.47      | —     | 0.60  |
| c1      | 0.46      | 0.51  | 0.56  |
| c2      | 0.47      | —     | 0.60  |
| D       | 6.00      | 6.10  | 6.20  |
| D1      | 5.25      | —     | —     |
| E       | 6.50      | 6.60  | 6.70  |
| E1      | 4.70      | —     | —     |
| e       | 2.186     | 2.286 | 2.386 |
| H       | 9.80      | 10.10 | 10.40 |
| L       | 1.40      | 1.50  | 1.70  |
| L1      | 2.90 REF  |       |       |
| L2      | 0.508 BSC |       |       |
| L3      | 0.90      | —     | 1.25  |
| L4      | 0.60      | 0.80  | 1.00  |
| L5      | 0.15      | —     | 0.75  |
| L6      | 1.80 REF  |       |       |
| theta   | 0°        | —     | 8°    |
| theta 1 | 5°        | 7°    | 9°    |
| theta 2 | 5°        | 7°    | 9°    |

NOTES:  
ALL DIMENSIONS REFER TO JEDEC STANDARD  
TO-252 AA DO NOT INCLUDE MOLD FLASH OR  
PROTRUSIONS

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